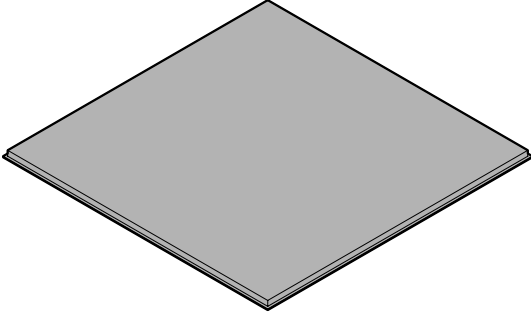
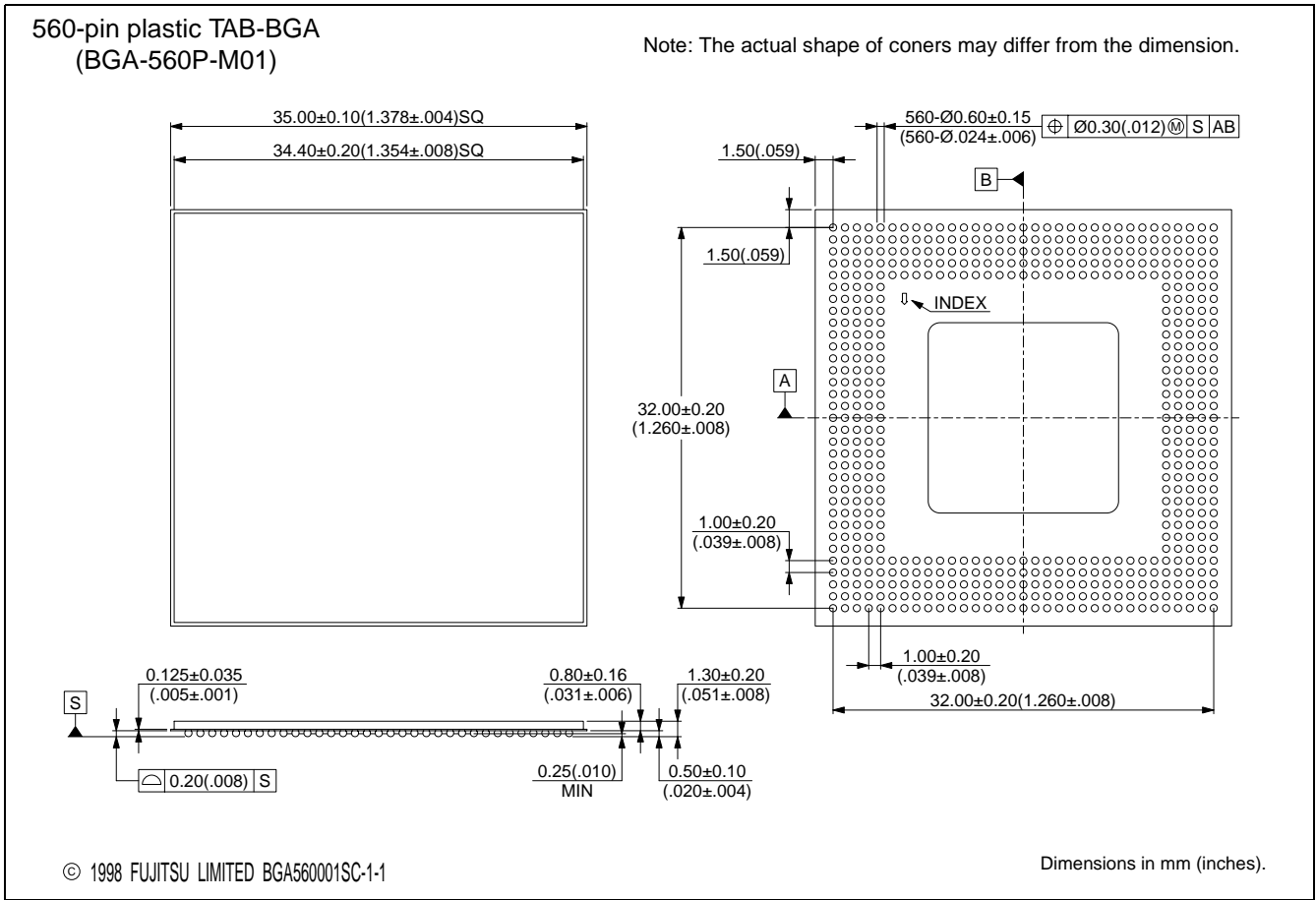


BGA-560P-M01

<p>560-pin plastic TAB-BGA</p>  <p>(BGA-560P-M01)</p>	Lead pitch	1.00 mm
	Package width × package length	35.00 × 35.00 mm
	Lead shape	Ball
	Sealing method	Resin seal
	Mounting height	1.50 mm Max



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